

Introduction

Thank you for participating in the Artix™-7 FPGAs Engineering Sample Program. As part of this program, we are pleased to provide to you engineering samples of the devices listed in [Table 1](#). Although Xilinx has made every effort to ensure the highest possible quality, these devices are subject to the limitations described in the following errata.

Devices

These errata apply to the devices shown in [Table 1](#).

Table 1: Devices Affected by These Errata

Product Family	Device	JTAG ID (Revision Code)	Packages	Speed Grades	Junction Temperature
Artix-7	XC7A100T CES	0	All	-1, -2	0°C to 85°C
	XC7A200T CES				
	XC7A100T CES9910				-40°C to 100°C
	XC7A200T CES9910				

Hardware Errata Details

This section provides a detailed description of each hardware issue known at the release time of this document.

IEEE Std 1149.1 Boundary-Scan

IEEE Std 1149.1 for Dedicated and SelectIO Resources (Applies only to XC7A100T Device)

IEEE Std 1149.1 (JTAG) boundary-scan test commands SAMPLE, PRELOAD, EXTEST, and HIGHZ are not functional. All other JTAG commands, including device configuration and the ChipScope™ debugging tool, function as expected.

Design Tool Requirements

The devices listed in [Table 1](#), unless otherwise specified, require the following Xilinx Design Tools:

- Speed specification v1.07 (or later) of Xilinx® ISE® Design Suite 14.4 or Vivado™ Design Suite 2012.4 with device pack (or later) available at <http://www.xilinx.com/support/download/>.
- For GTP transceiver attribute updates, refer to [Answer Record 47852](#).
- See Artix-7 FPGA [Answer Record 52049](#) for the most current known issues and work-arounds for Xilinx Design Tools.

Traceability

Figure 1 shows an example device top mark for the devices listed in Table 1.

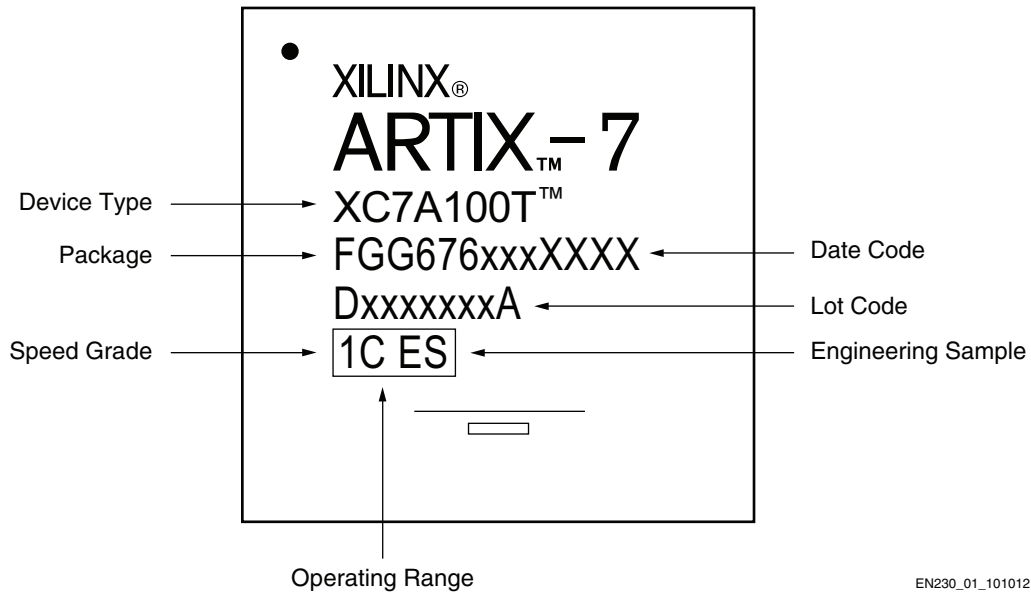


Figure 1: Example Device Top Mark

Additional Questions or Clarifications

For additional questions regarding these errata, contact Xilinx Technical Support:
<http://www.xilinx.com/support/clearxpress/websupport.htm> or your Xilinx Sales Representative:
<http://www.xilinx.com/company/contact/index.htm>.

Revision History

The following table shows the revision history for this document:

Date	Version	Description of Revisions
10/25/12	1.0	Initial Xilinx release.
05/03/13	1.1	Removed XADC-ADC Accuracy because the specifications are now included in the data sheet, DS181, <i>Artix-7 FPGAs Data Sheet: DC and Switching Characteristics</i> , v1.5, February 1, 2013. Updated Design Tool Requirements .

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